imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





SEMICONDUCTOR TM

FQB70N10 / FQI70N10 **100V N-Channel MOSFET**

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

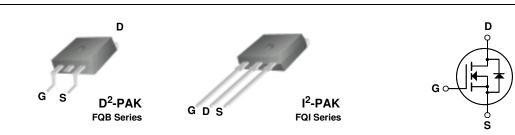
Features

* 57A, 100V, $R_{DS(on)} = 0.023\Omega @V_{GS} = 10 V$ * Low gate charge (typical 85 nC)

August 2000

ТΜ

- Low Crss (typical 150 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB70N10 / FQI70N10	Units
V _{DSS}	Drain-Source Voltage		100	V
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		57	А
			40.3	А
I _{DM}	Drain Current - Pulsed	(Note 1)	228	А
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1300	mJ
I _{AR}	Avalanche Current (Note 1)		57	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	16	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.75	W
	Power Dissipation $(T_C = 25^{\circ}C)$		160	W
- Derate above 25°C			1.06	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

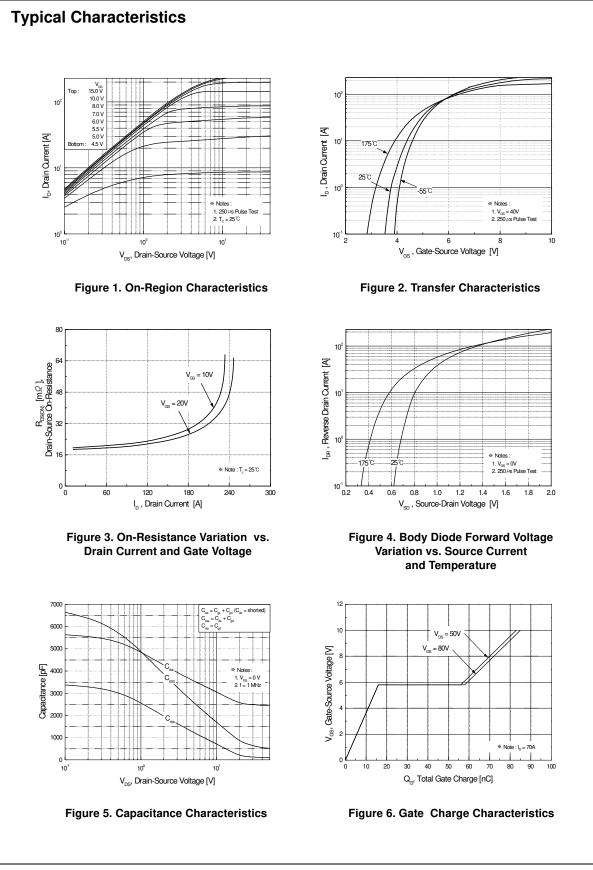
Thermal Characteristics

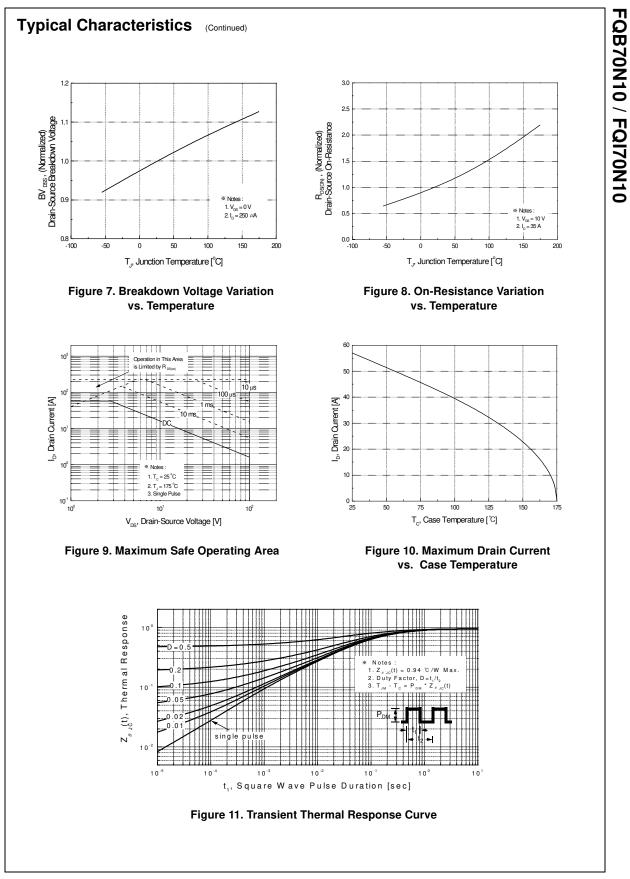
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.94	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

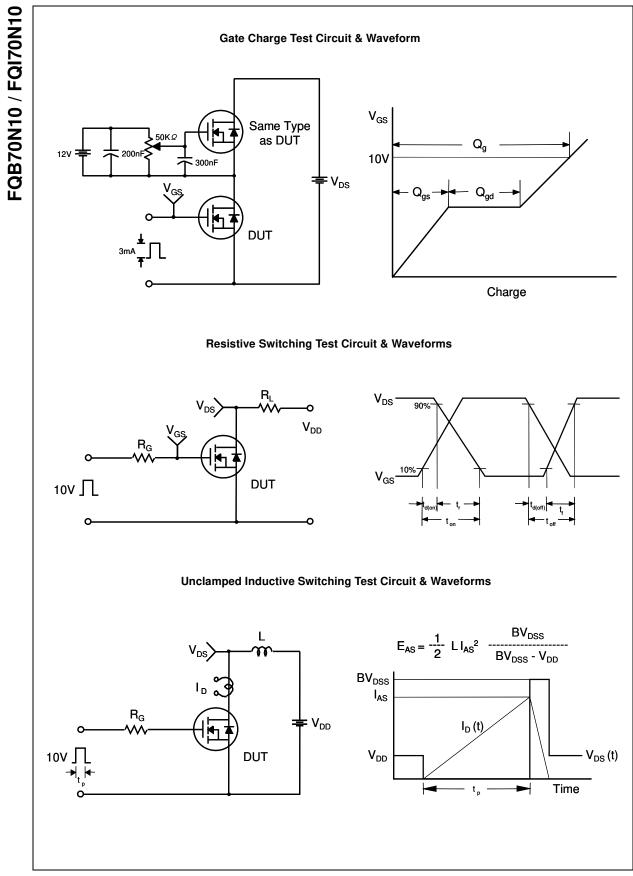
©2000 Fairchild Semiconductor International

Off Cha	Parameter	Test Conditions	Mi	Тур	Max	Units
	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	10			V
ΔBV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100 V, V _{GS} = 0 V			1	μA
		$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$			10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 25 V, V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 28.5 \text{ A}$		0.019	0.023	Ω
9FS	Forward Transconductance	V _{DS} = 40 V, I _D = 28.5 A (Note	4)	45		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		2500 720 150	3300 940 200	pF pF pF
	ing Characteristics	r			1	
Switch	Turn-On Delay Time	V _{DD} = 50 V, I _D = 70 A,		30	70	ns
Switchi d(on) r	Turn-On Delay Time Turn-On Rise Time	V_{DD} = 50 V, I _D = 70 A, R _G = 25 Ω		470	950	ns ns
Switchi d(on) r d(off)	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	$R_{G} = 25 \Omega$		470 130	950 270	
Switchi d(on) r d(off) f	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time			470 130 160	950 270 330	ns ns ns
Switchi d(on) r d(off) f Qg	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$R_{G} = 25 \Omega$		470 130 160 85	950 270 330 110	ns ns ns nC
Switchi td(on) tr td(off) tf Qg Qgs	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$R_{G} = 25 \Omega$ (Note 4 V _{DS} = 80 V, I _D = 70 A, V _{GS} = 10 V	, 5) 	470 130 160 85 16	950 270 330 110 	ns ns nS nC nC
Switchi d(on) r d(off) f Qg Qgs	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$R_{G} = 25 $ Ω (Note 4 $V_{DS} = 80 $ V, $I_{D} = 70 $ A,	, 5) 	470 130 160 85	950 270 330 110	ns ns ns nC
Switchi td(on) tr td(off) tf Qg Qg Qgd	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$R_{G} = 25 \Omega$ (Note 4 V _{DS} = 80 V, I _D = 70 A, V _{GS} = 10 V (Note 4	, 5) 	470 130 160 85 16	950 270 330 110 	ns ns ns nC nC
Switchi d(on) r d(off) f Qg Qgs Qgd	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	R_{G} = 25 Ω (Note 4 V_{DS} = 80 V, I_{D} = 70 A, V_{GS} = 10 V (Note 4 the Maximum Ratings	, 5) 	470 130 160 85 16	950 270 330 110 	ns ns ns nC nC
Switchi d(on) r d(off) f Qg Qgs Qgd Drain-S s SM	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics al Maximum Continuous Drain-Source Diode F	$R_{G} = 25 \ \Omega$ (Note 4 $V_{DS} = 80 \ V, \ I_{D} = 70 \ A,$ $V_{GS} = 10 \ V$ (Note 4 Ind Maximum Ratings ide Forward Current Forward Current	, 5) , 5) , 5)	470 130 160 85 16 42	950 270 330 110 	ns ns nC nC nC
Switchi d(on) r d(off) f Qg Qgs Qgs Qgd Drain-S s SM	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics al Maximum Continuous Drain-Source Diode F	$R_G = 25 \Omega$ (Note 4 V _{DS} = 80 V, I _D = 70 A, V _{GS} = 10 V (Note 4 od Maximum Ratings ode Forward Current	 5)	470 130 160 85 16 42	950 270 330 110 57	ns ns nC nC nC
Switchi d(on) r d(off) f Q _g Q _{gs} Q _{gd} Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics al Maximum Continuous Drain-Source Diode F	$R_{G} = 25 \ \Omega$ (Note 4 $V_{DS} = 80 \ V, \ I_{D} = 70 \ A,$ $V_{GS} = 10 \ V$ (Note 4 Ind Maximum Ratings ide Forward Current Forward Current	 	470 130 160 85 16 42	950 270 330 110 57 228	ns ns nC nC nC

FQB70N10 / FQI70N10

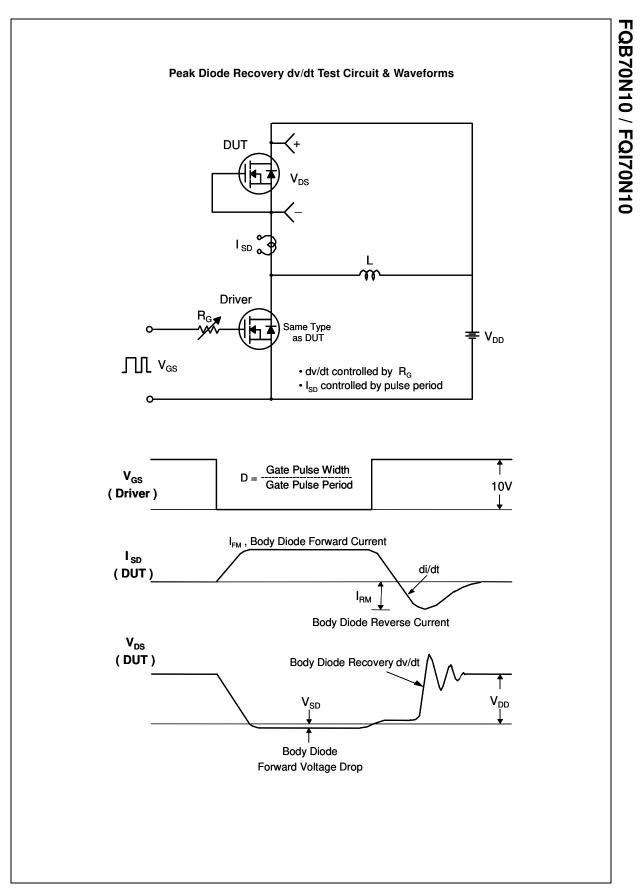






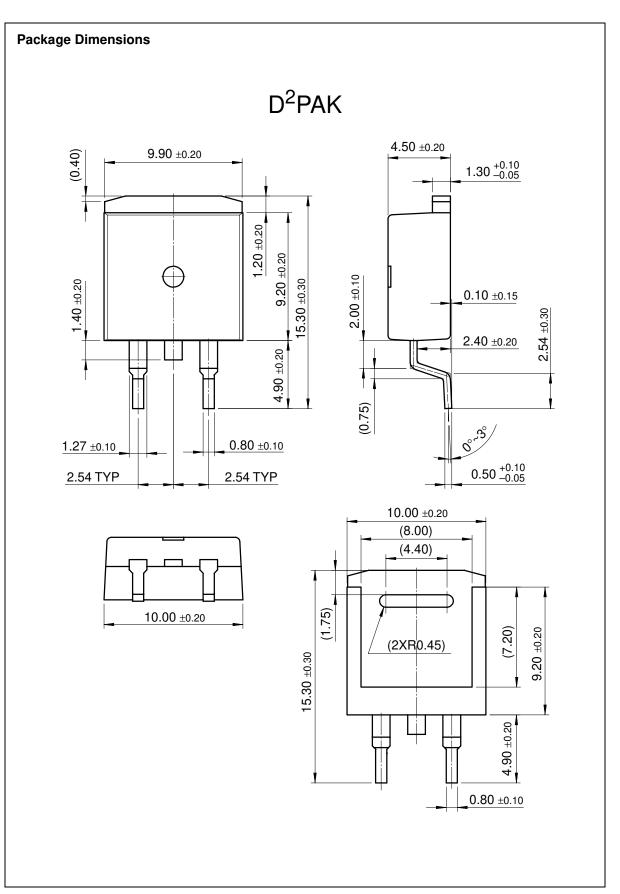
©2000 Fairchild Semiconductor International

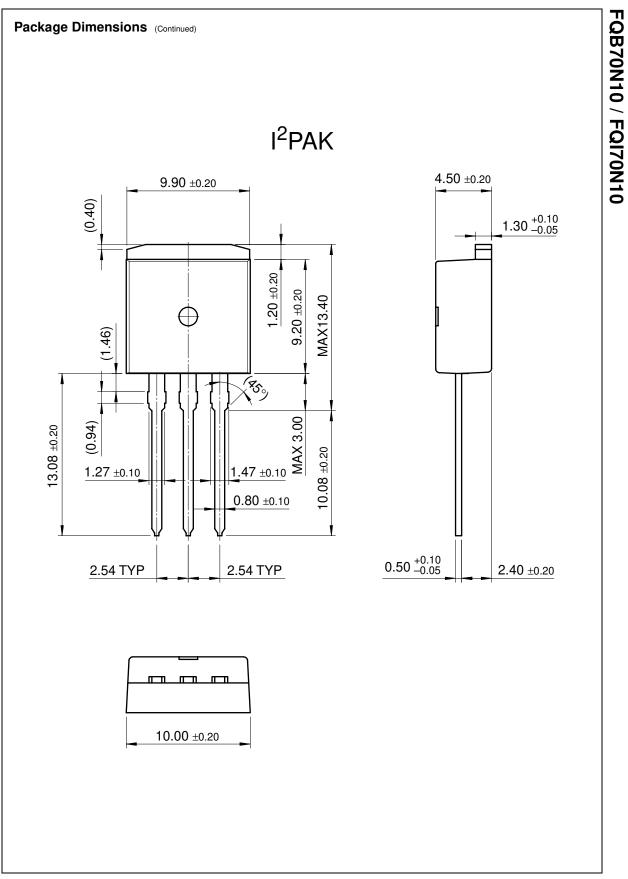
Rev. B, August 2000



©2000 Fairchild Semiconductor International

FQB70N10 / FQI70N10





©2000 Fairchild Semiconductor International

Rev. B, August 2000

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx [™]	FASTr™	QFET™	VCX™
Bottomless [™]	GlobalOptoisolator™	QS™	
CoolFET [™]	GTO™	QT Optoelectronics™	
CROSSVOLT [™]	HiSeC™	Quiet Series™	
DOME [™]	ISOPLANAR™	SuperSOT™-3	
E ² CMOS [™]	MICROWIRE™	SuperSOT™-6	
EnSigna [™]	OPTOLOGIC™	SuperSOT™-8	
FACT [™]	OPTOPLANAR™	SyncFET™	
0		•	

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR INTERNATIONAL.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.